Dwg. No. :<u>H22-1803</u>

承認字號

Issued Date: 2022/6/5

Customer	:	
(客 戶) Part No.	: VZH220M1VTR-0	0506
(貴公司料號)		

SPECIFICATION FOR APPROVAL

承認書

Description (零 件 名 稱)	:	V-CHIP ALUMINUM ELECTROLYTIC CAPACITORS
Lelon Series (立 隆 系 列)	:_	VZH Series
Lelon Part No	.:_	VZH220M1VTR-0506

LELON ELECTRONICS CORP.

立隆電子工業股份有限公司

Headquarters

i.47, Sec. 1, Guoguang Rd,. Dali District, Taichung, Taiwan TEL: +886-4-24181856 FAX: +886-4-24181906

Manufacturing Sites

- Lelon Electronics Corp.
 147, Sec. 1, Guoguang Rd,. Dali District, Taichung, Taiwan TEL: +886-4-24181856 FAX: +886-4-24181906
- Lelon Electronics (Huizhou) Co., Ltd.
 Taiyang Industrial Zone, Baihua Town, Huidong County, Huizhou City,
 Guangdong, China
- TEL: +86-752-8768222 FAX: +86-752-8768199

Lelon Electronics (Suzhou) Co., Ltd.
1220, Zhongshan North Rd., Wujiang Economic and Technological Technological Development Zone Suzhou City, Jiangsu, China

TEL: +86-512-63457588 FAX: +86-512-63457791

Approval Signatures

貴公司承認印

Approval	Check	Design
核 准	確 認	作 成
R & D JUN. 5. 2022 H. Y. Huang	R & D JUN. 5. 2022 J.H.Xiong	R & D JUN. 5. 2022 Z. X. Sun

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Part Numbering System

Product Code Guide - SMD Type

VE series	10µF	±20%	16V	Carrier Tape		4 ¢ × 5.3L	Pb-free	
<u>VE-</u>	<u>100</u>	<u>M</u>	<u>1C</u>	<u>TR</u>	-	<u>0405</u>		
1	2	3	4	5	6	7	8	9
Series	Capacitance	Capacitance Tolerance	Rated Voltage	Package Type	Terminal Type	Case size	Lead Wire	Supplement Code

1 Series:

Series is represented by a three-letter code. When the series name only has two letters, use a hyphen, "-", to fill the third blank.

2 Capacitance:

Capacitance in µF is represented by a three-digit code. The first two digits are significant and the third digit indicates the number of zeros following the significant figure. "R" represents the decimal point for capacitance under 10µF.

Example:

Capacitance	0.1	0.47	1	4.7	10	47	100	470	1,000	4,700
Part number	0R1	R47	010	4R7	100	470	101	471	102	472

3 Tolerance:

V 400/ 1400/	M 200/ 1200/	\/ 400/ 1000/
K = -10% ~ +10%	$M = -20\% \sim +20\%$	V = -10% ~ +20%

4 Rated voltage:

Rated voltage in volts (V) is represented by a two-digit code

iaioa voitago		(, , .	o . op. c		. ~, ~ .		,	•				
Rated Volt. (V)	4	6.3	10	16	20	25	35	40	50	63	80	100
Code	0G	0J	1A	1C	1D	1E	1V	1G	1H	1J	1K	2A
Rated Volt. (V)	160	200	250	350	400	450						
Code	2C	2D	2E	2V	2G	2W						

⑤ Package:

TR = Reel package	TT = Reel package of plastic	T- = Tray package for case diameter 12.5 ~ 18mm
-------------------	------------------------------	---

6 Terminal:

- = No dummy terminal	V = Anti-vibration structure
A = For application 10G (A must be used	with automotive control code "K / L" together)

7 Case size:

The first two digits indicate case diameter and the last two digits indicate case length in mm.

	o algito il	idiodic oc	acc alaili	otor arra t	110 1001 11	re algite i	naioato o	acc icing		
ϕ D×L	3×5.3	4×4.5	4×5.3	4×5.7 4×5.8*1	5×4.5	5×5.3	5×5.7 5×5.8*1	5×7*2	6.3×4.5	6.3×5.3
Code	0305	0404	0405	0406	0504	0505	0506	0507	0604	0605
φ DxL	6.3×5.7 6.3×5.8*1	6.3×7.0*2	6.3×7.7	6.3×8.7*2	8×6.5	8×10	10×7.7	10×10	10×12.5	12.5×13.5
Code	0606	0607	0607	0608	0806	0810	1008	1010	1013	1313
φ D×L	12.5×16	16×16.5	16×21.5	18×16.5	18×21.5					
Code	1316	1616	1621	1816	1821					

Note: *1.The case size "4x5.8, 5x5.8, 6.3x5.8" is for VZL, VZS, VZT series only.

- *2. The case size ard for VZR series only.
- 3. When a case size is required and not shown in the table, please contact with us for further discussion.

8 Lead Wire and Coating Type:

None = Pb free wire (Standard design)	E = Sn-Bi wire			
K / L = Automotive control code				

^{*} When a supplement code following a blank digit code of lead wire and case coating type (standard design), use a hyphen, "-", to fill the blank digit.

Supplement code (Optional):

For special control purpose

^{*} When the automotive control code is required, please contact with us for further discussion.

Lelon P/N: VZH220M1VTR-0506

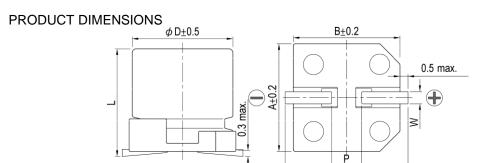
LELON ELECTRONICS CORP.

VZH 22 μ F / 35 V – 5 ϕ × 5.7L

Page: 1 / 1

CUSTOMER

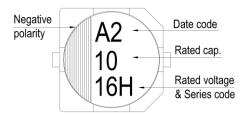
CUSTOMER P/N: VZH220M1VTR-0506



	Unit: mm
φD	5
L	5.7±0.3
Α	5.3
В	5.3
С	5.9
W	0.5~0.8
Р	1.5± 0.2

	Ţ	-	C±0.				-						
Items				Performance									
Rated Voltage V _R				35 V									
Capacitance C _R				22 µF			(120 Hz, 20°ℂ)						
Category Temperature Range		-55°C ~ +105°C											
Capacitance Tolerance		-20 % ~ +20 % (120 Hz, 20°C)											
Surge Voltage V _S				40.3 V _{DC}									
Leakage Current (20°C)				$I_{LEAK} \leqq 7.7~\mu\text{A}$			After 2 minutes						
Tan δ				≦ 0.13			(120 Hz, 20°ℂ)						
Impedance max.				0.80 Ω			(100k Hz, 20°℃)						
Ripple Current (I _{AC, R} / rms)		150 mA (100k Hz, 105											
Low Temperature Characteristics at 120 Hz		Impedance	npedance ratio $ \frac{Z_{(-25^{\circ})} / Z_{(+20^{\circ})}}{Z_{(-55^{\circ})} / Z_{(+20^{\circ})}} $			3							
Ripple Current (A) and	Freque	ncy (Hz)	50,60	120	1k	10k u	ıp						
Frequency Multipliers	Mult	tiplier	0.60	0.70	0.85	1.0							
	Items	Endura	ance		Shelf Life Te	est							
E 1 101 1/1 //	Test Time	2,000 H	Hrs at 105°	$C; V_R$	1,000 Hrs at	105℃							
Endurance and Shelf Life Test	Cap. Change	Within	±30 % of in	nitial value	Within ±30 %	6 of initial v	alue						
	Tan δ	Less th	nan 300% d	of specified value	Less than 30	cified value							
	Leakage Current	Within	specified v	alue	Within speci	fied value							
Standards		JIS C 5101-1, -18, IEC 60384-4											
Remarks			RoHS C	ompliance, Halo	gen-free								

Marking: Each capacitor shall be marked with the following information.



 $A \ 2 \rightarrow January , 2022$ The suffix of A. D.

Month of manufacture

Month	1	2	3	4	5	6
Code	Α	В	С	D	Е	F
Month	7	8	9	10	11	12
Code	G	Н	I	J	K	L

Marking color: Black

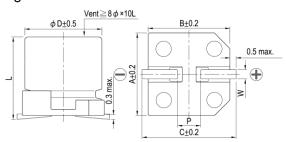
^{*} Please refer to "Precautions and Guidelines for Aluminum Electrolytic Capacitors" section in Lelon's catalog for further details.

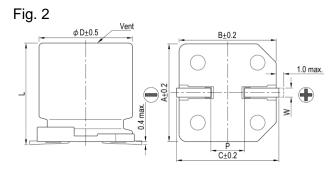
Publication Date	June 5, 2022	Approval Signatures:	Approved	Checked	Designed
Revision Date			R & D	R & D	R & D
Version No.	1	Please return one copy with your approval	JUN. 5. 2022 H. Y. Huang	JUN. 5. 2022 J.H.Xiong	JUN. 5. 2022 Z. X. Sun

Diagram of Dimensions:

Unit: mm

Fig. 1

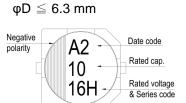


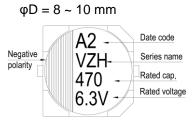


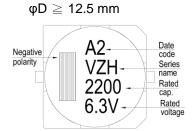
φD	L	Α	В	С	W	P ± 0.2	Fig. No.
4	5.7 ± 0.3	4.3	4.3	5.1	0.5 ~ 0.8	1.0	1
5	5.3 ± 0.2	5.3	5.3	5.9	0.5 ~ 0.8	1.5	1
5	5.7 ± 0.3	5.3	5.3	5.9	0.5 ~ 0.8	1.5	1
6.3	5.3 ± 0.2	6.6	6.6	7.2	0.5 ~ 0.8	2.0	1
6.3	5.7 ± 0.3	6.6	6.6	7.2	0.5 ~ 0.8	2.0	1
6.3	7.7 ± 0.3	6.6	6.6	7.2	0.5 ~ 0.8	2.0	1
8	6.5 ± 0.3	8.3	8.3	9.0	0.5 ~ 0.8	2.3	1
8	10 ± 0.5	8.3	8.3	9.0	0.7 ~ 1.1	3.1	1
10	7.7 ± 0.3	10.3	10.3	11.0	0.7 ~ 1.3	4.7	1
10	10 ± 0.5	10.3	10.3	11.0	0.7 ~ 1.3	4.7	1
10	12.5 ± 0.5	10.3	10.3	11.0	0.7 ~ 1.3	4.7	1
12.5	13.5 ± 0.5	13.0	13.0	13.7	1.1 ~ 1.4	4.4	2
12.5	16 ± 0.5	13.0	13.0	13.7	1.1 ~ 1.4	4.4	2
16	16.5 ± 0.5	17.0	17.0	18.0	1.1 ~ 1.4	6.4	2
16	21.5 ± 0.5	17.0	17.0	18.0	1.1 ~ 1.4	6.4	2
18	16.5 ± 0.5	19.0	19.0	20.0	1.1 ~ 1.4	6.4	2
18	21.5 ± 0.5	19.0	19.0	20.0	1.1 ~ 1.4	6.4	2

Marking:

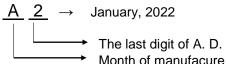
Each capacitor shall be marked with the following information.







Description of Date Code:



WOTHITO	i illalik	JIGCUIT				
Month	1	2	3	4	5	6
Code	Α	В	С	D	Е	F
Month	7	8	9	10	11	12
Code	G	Н	I	J	K	L

Origin code:

Huizhou: A2, B2, ..., K2, L2 Suzhou: 2A, 2B, ..., 2K, 2L

Marking Color: Black

Taping Specification for SMD Type

1. Carrier Tape

Fig. 1-3

Fig. 1-3	P2	P1 P	0000	₩ •-•	<u>t1</u>	
						Feeding Hole
	⊕ ⊕ ⊕ ⊕ ⊕ ⊕ Feeding F	⊕ ⊕ o o o o o	0000	0 0	+2	

		Feeding Hole		_ A		t2						Unit: mm
φD×L	Α	В	ϕ d	F	Р	P1	P2	t1	t2	W	W1	Fig. No.
3~4 ×4.5	4.5	4.5		5.5	8				4.8			4.4
4 ×5.3	4.5	4.5		5.5	8				5.8			1-1
4 ×5.7	4.5	4.5		5.5	8				6.3	12.0		
5 ×4.5	5.5	5.5		5.5	12				4.8			
5 ×5.3	5.5	5.5		5.5	12				5.9			
5 ×5.7 ~ 5.8	5.5	5.5		5.5	12				6.3			
6.3 ×4.5	6.8	6.8		7.5	12			0.4	4.8			
6.3 ×5.3	6.8	6.8							5.9			
6.3 ×5.7 / 5.8	6.8	6.8		7.5	12				6.3	16.0		
6.3 ×7.7	6.8	6.8							8.3			
6.3 ×8.7	6.8	6.8							9.3			4.0
6.3 ×9.5	6.8	6.8		11.5	16	1		0.5	9.8	24.0		1-2
8 ×6.5	8.7	8.7		7.5	12	1			6.9	16.0		
8 ×9.5~10									11.0			
8 ×10.5(G)	9.4	9.4		11.5	16				11.4	24.0		
10 ×7.7	10.7	10.7				2.0	4.0		8.7			
10 ×10			1.5						11.0		1.75	
10 ×10.5(G)	11.4	11.4							11.4			
10 ×12.5	10.7	10.7							13.1			
10 ×13.5	10.7	10.7							14.5	-		
10 ×14.5	10.7	10.7							15.5			
10 ×16.5	10.7	10.7							17.5	-		
12.5 ×13.5	13.4	13.4				1			14.5			
12.5 ×13.5(G)	13.7	13.7		14.2	24				15.0	32.0		
12.5 ×16	13.4	13.4							17.0	-		
12.5 ×16(G)	13.7	13.7						0.5	17.5		-	
16 ×16.5	17.5	17.5							17.0	-		1-3
16 ×16.5(G)	17.5	17.5			28				17.5	44.0		
16 ×21.5	17.5	17.5	1	20.2					23.0			
18 ×16.5	19.5	19.5	1		00				17.5			
18 ×16.5(G)	19.6	19.6			32				17.5			
18 ×21.5	19.5	19.5	1						23.0			
Tol.	± 0.2	± 0.2	+0.1/-0	± 0.1	± 0.1	± 0.1	± 0.1	± 0.1	± 0.2	± 0.3	± 0.15	

Note: Case size in mark of "G" are for "Anti-vibration".

LELON ELECTRONICS CORP. PAC-SMD

2. Reel Package

Fig. 2-1

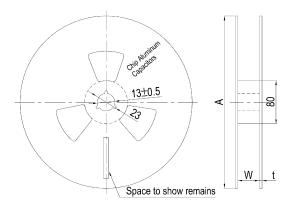
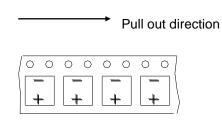
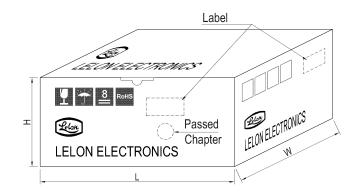


Fig. 2-2 Reel Polarity



Case size	3 ~ 4 ¢	5φ	6.3φ×4.5~8.7	8φ×6.5 ~ 7L	8 ¢ ×10	10 <i>ϕ</i>	12.5 ¢	16 ~ 18 φ
W	14	14	18	18	26	26	34	46
Α	380	380	380	380	380	380	380	380
t	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0

3. Packing specification Fig. 3-1 Carrier Tape



Unit: pcs

Case size	Q'ty / Reel	Q'ty / Box
3 <i>ϕ</i>	2,000	20,000
4 φ	2,000	20,000
5φ	1,000	10,000
$6.3 \phi \times 4.5 L$	1,500	15,000
$6.3 \phi \times 5.3 \sim 7.7 L$	1,000	10,000
6.3 <i>φ</i> ×8.7L	800	8,000
6.3 ¢ ×9.5L	500	5,000
8 φ × 6.5~6.7	1,000	10,000
8 φ ×10L	500	5,000
10 φ ×7.7 ~ 10L	500	5,000
10 φ ×12.5~13.5L	400	4,000
10 ¢ ×16.5L	300	3,000
12.5 φ ×13.5L	200	1,600
12.5 ¢ ×16L	200	1,600
16 φ ×16.5L	200	1,600
16 ¢ ×21.5L	100	800
18 ¢ ×16.5L	150	1,200
18 ϕ ×21.5L	100	800

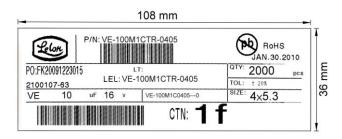
Unit: mm

Case size	$3 \sim 4 \phi$	5ϕ	6.3φ×4.5~8.7	8φ× 6.5 ~ 7L	$8\phi \times 10$	10 <i>φ</i>	12.5 ¢	16 ~ 18 ¢
Н	210	210	250	250	330	330	330	425
W, L	395	395	395	395	395	395	395	395

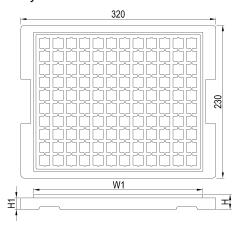
Ver. 13 -2-

LELON ELECTRONICS CORP. PAC-SMD

Fig. 3-2 Label



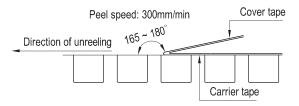
4. Chip Tray



Dimension and package quantity Unit											
Case size	ase size W1 H H1 Q'ty / Tray										
12.5 φ ×13.5L	284	21	18.5	120	600						
12.5 φ ×16L	284	21	18.5	120	600						
16 <i>ф</i> ×16.5L	284	28	24.0	80	400						
16 φ ×21.5L	284	28	24.0	80	400						
18 <i>ф</i> ×16.5L	284	28	24.0	60	300						
18 φ ×21.5L	300										

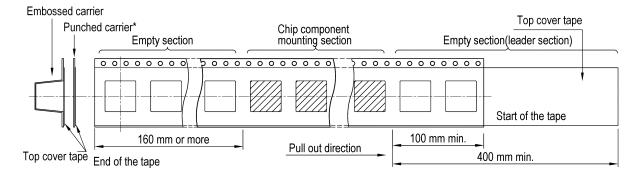
5. Sealing Tape Reel Strength

- 5.1 Peel angle: 165 to 180°C refered to the surface on which the tape is glued.
- 5.2 Peel speed: 300mm per minutes
- 5.3 The peel strength must be 0.1 ~ 0.7N under these conditions.



6. Packing Method

- 6.1 The leader length of the tape shall not be less than 400 mm including 10 or more embossed sections in which no parts are contained.
- 6.2 The winding core is provided with an over 160mm long empty section; punched carrier is only suitable for ϕ D \leq 5 mm.



7. Other: Specifications stated above is in accordance with JIS C 0806-3.

Ver. 13 -3-

Endurance characteristic:

	urance cnaractei	าอแบ												
No.	Item			nditio							Spe	cificati	on	
1	Rotational Temperature Test		acitor is placed in a v specific regulation					:	Capacit change	ance	Within ±	: 10% (of initial value	
	remperature rest		ation is " +25°C (3	_	-	Tanδ	,	Within s	necifie	d value				
		_	\mathbb{C} (3 min.) \rightarrow +105	Leakage	2									
			", and it is called a						Current		Within s	pecifie	d value	
			s, and then the ca						Physica	I I	No brok	en and	l undamaged	
			dard atmospheric on measurements s				s, atter							
2	High Temperature		apacitors shall be p						Capacit	ance ,	M/ithin .	200/	of initial value	
	Endurance Life		plication of rated v						change					
	Test		000 +72 / -0 hours	-	$0 \le 6.3$	3mm, 8	3φ×		Tanδ		Less tha	an 300	% of specified	value
			Smm and $10 \phi \times 7$.		3 > 0				Leakage		Within s	pecifie	d value	
			000 +72 / -0 hours mm at 105°C	iorφL	J <u> </u>	nm an	0 L <u>≤</u>		Current Physica			-	l undamaged	
		_	en the capacitor s	hall be	subjec	cted to			Titysica		INO DION	CII and	rundamaged	
		st	andard atmospher	ic cond	ditions	for 4 h	ours,							
3	High Temperature		ter which measure 1,000 +48 / -0 hou						Capacit	onoo				
3	Unload Life Test		I voltage. And ther				ilout		change	ance	Within ±	30% (of initial value	
			ubjected to standa		-		ditions		Tanδ	1	Less tha	an 300	% of specified	value
		for 4	hours, after which		-				Leakage	э,			d value	
		made	Э.						Current			-		
	11 12 7	0							Physica		No brok	en and	undamaged	
4	Humidity Test		acitors shall be exp s in an atmosphere						Capacit change	ance	Within ±	of initial value		
		3°C.	o in an aimeopher	0.00	0070	, , , , , , , ,	u. 00 _		Tanδ	ı	Less than 120% of specified value			
			then the capacitor						Leakage	2	Within specified value			
			dard atmospheric of				s, after		Current			-		
_	1		n measurements s				4 1		Physica		No broken and undamaged			
5	Low Temperature Test		acitors are placed a then the capacitor					5.	Capacit change	ance	Within ±10% of initial value			
			dard atmospheric o		-				Tanδ	١	Within specified value			
		whicl	n measurements s	hall be	made				Leakage		Within specified value			
									Current		<u> </u>			
6	Vibration Test	1 Fiv	k it at the point 4 m	m or l	ass fro	m hodi	, For		Physica Capacit		No broken and undamaged			
	Vibration rest		es of 12.5 mm or r						change	arice	Within ±	: 10% (of initial value	
		or	more length, use s	epara	te fixtur	e.			Tanδ	,	Within s	pecifie	d value	
			rection and during						Leakage		Within s	pecifie	d value	
			orthogonal direction tal of 6 hours).	ns mut	ually ea	ach for	2 hours	S	Current Physica			•	l undamaged	
			equency:						Tityoloa	' l'	I VO DION	on and	i diladillagea	
			to 55 Hz reciproca		or 1 mir	nute.								
7	Surge Voltage Test		tal amplitude: 1.5 capacitor shall be:		ted to 1	1.000 c	vcles a	t	Capacit	ance				
			35°C. Protective s					•	change		vvithin ±	20% (of initial value	
		cons	isting of a charge	period	of 30 ±	5 sec	onds,		Tanδ		Less tha	an 175	% of specified	value
		_	ved by discharge p	eriod	of appr	oximat	tely 5.5		Leakage		Within s	pecifie	d value	
		minu	tes.						Current Physica			-		
		Annly	ying voltage:		i ilysica	.	140 DIOK	on and	l undamaged					
		Rated Voltage(V) 6.3 10 16 25 38							5 50	63	80	100		
			Surge Voltage(V)	7.3	11.5	18.4	28.8	40		72.5		115		
					I	<u> </u>	1		1			I———	J	

No.	Item	Conditions						Specification				
8	Solder Heat-	1. IR Reflow						Capacitance	Within ± 10% of initial value			
	Resistance Test	T4				- -t	3-	change Tanδ				
		Т3				/		Leakage	Within specified value			
		(C)						Current	Within specified value			
		Temperature(°C)			/			Physical	No broken and undamaged			
		ນິອີດ T1		t1		tí	,					
		Ter	/ 1		-	-	-					
			/									
							Time(sec)					
		Rated	Rated voltage (V) 4 ~ 50 63 up 4 ~ 100									
			e size (ϕ)	3 ~ 6		3 ~ 6.3	8 ~ 18					
			Temp.		15	0 ~ 180						
		Preheat	(T1 ~ T2,°C) Time (t1)			100						
			(max., secs)	0.47	000	100	047 000					
		Duration	Temp. (T3, °C) Time (t2)		230	217	217 230					
			(max., secs)	90	60	60	60 40					
		Peak	Temp. (T4, °C)	260)	250 5	250					
		Ref	Time (t3, secs)		2							
		Reflow cycles 2 or less 2. Solder iron method:										
			erature: 350 ± 60		'on: 2 I	1 / 0 0	20					
			contact our rep									
		higher.			ما سمد:		مة ماسينمسم امان					
		* Please ensure that the capacitor became cold enough to the room temperature (5°C ~ 35°C) before the second										
		reflow.	·	•	•							
			with us when (J-STD-020)	pertorn	ning reti	ow pro	rile in IPC /					
9	Mechanical	Bending Tes	st:		• • •				nanical damage such as			
	Characteristics Test		ssure in the dir mm / s until be		lectrical characteristics shall be If there are electrodes on both							
		about 0.5 mm / s until bent width reaches 2 mm and hold for 60s. The board shall be the test board "B" as specified i JIS C 0051: 2002. If the land area differs, it shall be specified clearly in the next item.						surfaces, above requirements shall be satisfied on whichever surface it may be fixated on.				
		Substrate Substrate during test										
									20 mm Bending tool			
		Substrate during test before test						Radius 5				
		1,6 mm ± 0,20 mm										
						Support Radius 2,5 r	nm	i	Length = actual width			
		Specimen (of SMD) ~	45 mm ± 2 mm 45	mm ± 2 mm	Solder			·	of substrate + 5 (minimum) on both sides			
10	Solderability					solder f	or 2 ± 0.5 secs	at a temperatu	re of 245 ± 5°C, the solder the			
11	Test Venting Test		ng must be mo e to the capaci			size is	8x10 mm and	larger.				
		2. Test cond	lition:					_				
		(1) AC tes					across an app chever is the		Iz AC which is 0.7 times of			
			st: Applying inv	erse D	C rated	voltage	e with current	to the capacitor.				
		Where	case diamete									
		Note:		φυ	> 22.4	mm: 10	A DC max.					
		(1) When	the pressure re	elief ve	nt opera	ated, th	e capacitor sh	all avoid any da	nger of fire or explosion of			
			tor element (te					oltage applied (over 30 minutes, the test is			
(2) When the pressure relief device does not open with the voltage applied over 30 minutes, the considered to be passed.						5.5. 55 mmatos, the total						

No.	Item	Conditions									
12	Land Pattern	Recommended pad pattern and size									
		C	Case size	L	and siz	:e	Case size	L	and siz	e	
		G		G	Υ	X		G	Υ	X	
			4ϕ	1.0	2.6	1.6	8 <i>¢</i>	3.0	3.5	2.5	
		*/////////////////////////////////////	5φ	1.4	3.0	1.6	10 <i>ϕ</i>	4.0	4.0	2.5	
			6.3 ¢	1.9	3.5	1.6	12.5 <i>ϕ</i>	4.0	6.0	3.2	
		: pad	8 ¢ ×6.5L	2.1	4.0	1.6	16 <i>ϕ</i>	6.0	7.0	3.2	
							18 <i>ϕ</i>	6.0	8.0	3.2	

Precautions and Guidelines for Aluminum Electrolytic Capacitors

1. Guidelines for Circuit Design (General / Application guidelines for using electrolytic capacitors)

Selecting of a right capacitor is a key to a good circuit design.

(1) Polarity

Most of the aluminum electrolytic capacitors are polarized. Therefore, they must be installed with the correct polarity. Usage in the reverse polarity results into a short-circuit condition that may damage or even explode the capacitor. In addition, it may influence circuit functionality. A bi-polar electrolytic capacitor should be installed when polarity across a capacitor is unstable / reversible. It should be, however, noted that usage of both polar and bi-polar capacitors are limited to DC applications. They must NOT be used for AC application.

(2) Operating Voltage

Applied DC voltage must not exceed rated voltage of the capacitor. Applying higher voltage than its rated voltage across a capacitor terminals cause overheating due to higher leakage currents and capacitor dielectric/insulation deterioration that will ultimately affect a capacitor's performance. The device, however, is capable of working under short-time transient voltages such as DC transients and peak AC ripples. Reverse voltages higher than 1 Volt within a specified temperature limit or AC voltages are not permissible. Overall, using capacitors at recommended operating voltages can prolong its lifespan. Note that the result of DC voltage overlapped with peak ripple voltage should not exceed rated voltage.

(3) Ripple Current

One of the key functions of any capacitor is removal of the ripple current i.e. the RMS value of AC flowing through a capacitor. But, a ripple current higher than rated ripple current will drop resultant capacitance, cause undue internal heating and thus reduces life span of the capacitor. In extreme cases, internal high temperature will cause the pressure relief vent to operate while destroying the device. Overall, it is important to note that an electrolytic capacitor must be used within a permissible range of ripple current. Indicators like temperature coefficient of allowable ripple current are generally used to determine life expectancy of the capacitor, but to avoid related complex calculations and for the sake of simplicity, we haven't provided temperature coefficient in the catalogue. But it offers key indicators like maximum operating temperature for calculation of life expectancy at a given temperature.

(4) Operating Temperature

Capacitors should be used within a permissible range of operating temperatures. Using capacitor at a higher temperature than maximum rated temperature will considerably shorten its life. In the worst-case scenario, high temperature can cause pressure relief vent to operate and the device will get destroyed. Using capacitors at an ambient room temperature assure their longer life.

(5) Leakage Current

Leakage current flows through a capacitor when DC voltage is applied across it. Leakage current varies with changes in ambient temperature and applied DC voltage level and its time of application. Overvoltage situation, presence of moisture, and thermal stresses, especially occurring during the soldering process can enhance leakage current. Initial leakage current is usually higher and does not decrease until voltage is applied for a certain period of time. It is recommended to keep initial leakage current within specified levels.

(6) Charge and Discharge

Regular electrolytic capacitors are not suitable for rapid charging/discharging circuits. Such usage may either cause reduction in overall capacitance or damage due to overheating. Lelon provides special assistance for selecting appropriate capacitors for rapid charging/discharging circuits.

(7) Surge Voltage

The Surge voltage rating is referred as the maximum DC overvoltage that may be applied to an electrolytic capacitor for a short time interval of 30 seconds at infrequent time intervals not exceeding 5.5minutes with a limiting resistance of $1k\Omega$. Unless otherwise described on the catalogue or product specifications, please do not apply a voltage exceeding the capacitor's voltage rating. The rated surge voltages corresponding to rated voltages of electrolytic capacitors are presented as follows:

Rated Voltage(V)	4	6.3	10	16	25	35	50
Surge Voltage(V)	4.6	7.3	11.5	18.4	28.8	40.3	57.5
Rated Voltage(V)	63	80	100	160	200	250	315
Surge Voltage(V)	72.5	92	115	184	230	288	347
Rated Voltage(V)	350	400	420	450	500	525	
Surge Voltage(V)	385	440	462	495	550	578	

(8) Condition of Use

The capacitors shall NOT be exposed to:

- (a) Fluids including water, saltwater spray, oil, fumes, highly humid or condensed climates, etc.
- (b) Ambient conditions containing hazardous gases/fumes like hydrogen sulfide, sulfurous acid, nitrous acid, chlorine or bromine gas, ammonia, etc.
- (c) Exposed to ozone, ultraviolet rays and radiation.
- (d) Severe vibrations or physical shocks that exceeds the specifications mentioned in this catalogue.

(9) Circuit Design Consideration

- (a) Please ensure whether application, operating and mounting conditions satisfy the conditions specified in the catalog before installation of a capacitor. Please consult Lelon, if any of the conditions are beyond the conditions specified in the catalog.
- (b) Heat-generating components or heat sinks should not be placed closer to Aluminum electrolytic capacitors on the PCB to avoid their premature failure. A cooling system is recommended to improve their reliable working.
- (c) Electrical characteristics and performance of aluminum electrolytic capacitors are affected by variation of applied voltage, ripple current, ripple frequency and operating temperature. Therefore, these parameters shall not exceed specified values in the catalog.
- (d) Aluminum capacitors may be connected in the parallel fashion for increasing total capacitance and/or for achieving higher ripple current capability. But, such design may cause unequal current flow through each of the capacitors due to differences in their impedances.
- (e) When two or more capacitors are connected in series, voltage across each capacitor may differ and fall below the applied voltage. A resistor should be placed across each capacitor so as to match applied voltage with voltage across a capacitor.
- (f) Please consult Lelon while selecting a capacitor for highfrequency switching circuit or a circuit that undergoes rapid charging/ discharging
- (g) Standard outer sleeve of the capacitor is not a perfect electrical insulator therefore is unsuitable for the applications that requires perfect electrical insulation. Please consult Lelon, if your application requires perfect electrical insulation.
- (h) Tilting or twisting capacitor body is not recommended once it is soldered to the PCB.

2. Caution for Assembling Capacitors

(1) Mounting

 (a) Aluminum electrolytic capacitors are not recommended to reuse in other circuits once they are mounted and powered in a circuit.

- (b) Aluminum electrolytic capacitors may hold static charge between its anode and cathode, which is recommended to be discharged through a 1kΩ resistor before re-use.
- (c) A long storage of capacitors may result into its insulation deterioration. This can lead to a high leakage current when voltage is applied that may damage the capacitor. Capacitors following a long storage period must undergo voltage treatment/re-forming.
 - Capacitors are charged by applying rated DC voltage through a resistor of $1k\Omega$ in series at least for an hour. It is recommended to increase applied voltage gradually using a voltage regulator unit once capacitors are assembled on the board. The charging should be followed by discharging through a $1k\Omega$ resistor.
- (d) Please check capacitor rated voltage before mounting.
- (e) Please check capacitor polarity before mounting.
- (f) Please don't drop capacitor on the floor / hard object.
- (g) Please don't deform the capacitor during installation.
- (h) Please confirm whether the lead spacing of the capacitors match with its pad spacing / footprint on PCB prior to installation.
- Please avoid excessive mechanical shocks to capacitor during the auto-insertion process, inspection or centering operations.
- (j) Please don't place any wiring or circuit over the capacitor's pressure relief vent. The pressure relief vent may fail to open if adequate clearance space is not provided. Following table shows minimum clearance space required for different case diameters.

Case Diameter	φ6.3 ~ φ16	φ18 ~ φ35	ϕ 40 or above		
Clearance (min)	2 mm	3 mm	5 mm		

(2) Soldering

- (a) Please confirm that soldering conditions, especially temperature and contact time are within our specifications. Dip or flow soldering temperature should be limited at 260 ± 5°C for 10 ± 1 sec while manual soldering using soldering iron should be limited at 350 ± 5°C for 3 +1/-0 seconds. Please do not dip capacitor body into molten solder. A capacitor's life will be negatively affected if these conditions are violated.
- (b) Storage of capacitors in *high humidity* conditions is likely to *affect* the *solder-ability of lead wires and terminals*.

- (c) Reflow soldering should NOLY be used for SMD type capacitors. The temperature and duration shall not exceed the specified temperature and duration in the specification. If the temperature or duration is higher than the value specified, please consult Lelon before usage.
- (d) Standard aluminum electrolytic capacitors are not designed to withstand multiple reflow processes. Please consult Lelon if repeated reflowing is unavoidable.
- (e) Incorrect mounting on PCB with improper external strength applied on its lead wires or capacitor body after soldering may damage a capacitor's internal structure, cause short circuit, or lead to high leakage current issues. Do not bend or twist the capacitor body after soldering. Referring to the drawings below only case (i) is recommended.
 - (i) Correct soldering

environment.

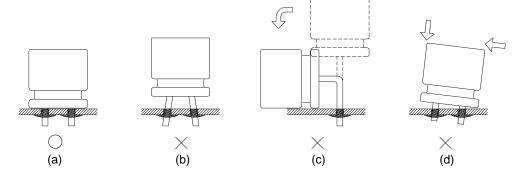
- (ii) Hole-to-hole spacing on PCB differs from the lead space of lead wires.
- (iii) Lead wires are bent after soldering.
- (iv) Capacitor body doesn't stand vertical on PCB after soldering.

(3) Cleaning Circuit Boards after Soldering

- (a) Following chemicals are not recommended for cleaning: Solvent containing halogen ions, Alkaline solvent, Xylene, Acetone, Terpene, petro-based solvent.
- (b) Recommended cleaning conditions:
 Fatty-alcohol Pine Alpha ST-100S, Clean Through-750H and IPA (isopropyl alcohol) are examples of the most acceptable cleaning agents. Temperature of the cleaning agent must not exceed 60°C. Flux content in the cleaning agents should be limited to 2 Wt. %. Overall length of cleaning process (e.g., immersion, ultrasonic or other) shall be within 5 minutes (5 ~ 7mm height within 3 minutes). CFC substitute cleaning agents such as AK225AES can also be used for cleaning. In this case, its temperature shall not exceed 40 C and cleaning process (e.g., immersion, ultrasonic or other) shall be completed within 2 ~ 3 minutes. After cleaning capacitors should be dried with hot air for at least 10 minutes along with the PCB. Temperature of hot air shall not exceed maximum category temperature of the capacitor. Insufficient drying may cause appearance defects,

sleeve shrinkage, and bottom-plate bulging. However, usage of

this CFC substitute must completely regulated for protection of



3. Maintenance Inspection

Periodical inspection of aluminum capacitors is absolutely necessary, especially when they are used with industrial equipment. The following items should be checked:

- (1) Appearance: Bloated, vent operated, leaked, etc.
- (2) Electrical characteristic: Capacitance, Tanδ, leakage current, and other specified items listed in specification.

Lelon recommend replacing the capacitors if any of the abovementioned items fail to meet specifications.

4. Storage

- (1) The most suitable conditions for aluminum capacitor storage are 5 °C ~ 35°C and indoor relative humidity less than 75%. High temperature and/or humidity storage is detrimental to the capacitors.
- (2) Capacitors shall not be stored in wet or damp atmospheres containing water, brine, fumes or oil.
- (3) Capacitors storage area shall neither be exposed to hazardous gases such as hydrogen sulfide, sulfurous acid, nitrous acid, chlorine, ammonium, etc. nor to acidic or alkaline solutions.
- (4) Capacitors shall not be exposed to ozone, ultraviolet rays or radiation.

5. Estimation of life time

 $L_{r}=L_{0}\times2^{\frac{T_{0\max}-T_{r\max}}{10}}$

L_r: Estimated lifetime (hours)

 L_0 : Base lifetime specified at maximum operating temperature with applied the DC voltage

 $T_{0 \; \text{max}}$: The core temperature that rated ripple current applied at maximum operating temperature.

 $T_{\text{r\,max}}$: The core temperature that applied actual ripple current at ambient temperature.

6. Disposal

Please consult with a local industrial waste disposal specialist when disposing of aluminum electrolytic capacitors

7. Environmental Consideration

Lelon already have received ISO 14000 certificate. Cadmium (Cd), Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr⁺⁶), PBB, PBDE, DEHP, BBP, DBP and DIBP have never been using in capacitor. If you need "Halogen-free" products, please consult with us.

8. AEC-Q200 Compliance

Automotive Electronics Counsel (AEC) has established various electronic component qualification/reliability standards in order to serve automotive electronics industry. AEC-Q200 standard is dedicated for passive components like capacitors, inductors, etc. and is widely adopted domestically as well as internationally. Lelon offers compliant product designs and support services to satisfy customers' product requirements, including the AEC-Q200 required criteria of the reliability tests. Lelon's capacitors are professionally designed to outperform all requirements of AEC-Q200.

For further details, please refer to

IEC 60384-4- Fixed capacitors for use in electronic equipment – Part 4: Sectional specification – Aluminium electrolytic capacitors with solid (MnO₂) and non-solid electrolyte (Established in January 1995, Revised in March 2007), and

EIAJ RCR-2367B- Guideline of notabilia for fixed aluminium electrolytic capacitors for use in electronic equipment [Technical Standardization Committee on Passive Components (Established in March 1995, Revised in March 2002)].